

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	321	((cmp or planariz\$4 or polish\$4) with (edg\$4 or circumfranc\$4 or perimeter or outer or peripher\$4) with (wafer or substrate) with (lower low shallow\$4 height bevel facet slope sloped sloping inclin\$4)).ab.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/11 20:45
L2	196	L1 and (@ad < "20010123")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/11 20:45
L3	122	((cmp or planariz\$4 or polish\$4) with (edg\$4 or circumfranc\$4 or perimeter or outer or peripher\$4) near4 (lower thin\$4 bevel\$4 facet\$4 round\$4 inclin\$4 declin\$4) with (wafer or substrate)).ab.	US-PGPUB; USPAT; DERWENT; IBM_TDB	OR	ON	2006/08/11 20:48
L4	59	L3 and (@ad < "20010123")	US-PGPUB; USPAT; DERWENT; IBM_TDB	OR	ON	2006/08/11 20:51
L5	1777573	substrate wafer	US-PGPUB; USPAT; DERWENT; IBM_TDB	OR	ON	2006/08/11 20:49
L6	5491529	edg\$4 or circumfranc\$4 or perimeter or outer or peripher\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/11 20:50
L7	34084	conformal\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/11 20:50
L8	385	5 same 7 and 7 near4 6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/11 21:36
L9	210	8 and (@ad < "20010123")	US-PGPUB; USPAT; DERWENT; IBM_TDB	OR	ON	2006/08/11 21:21

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L10	14	5 same 7 and 7 near4 6 near4 (narrow\$4 thin\$4 ledge)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/11 20:56
L11	149	5 same 7 and 7 with 6 with (lower thin\$4 bevel\$4 facet\$4 round\$4 inclin\$4 declin\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/11 21:21
L12	67	11 and (@ad < "20010123")	US-PGPUB; USPAT; DERWENT; IBM_TDB	OR	ON	2006/08/11 21:20
L13	1621054	die dice chip ic integrated adj circuit	US-PGPUB; USPAT; DERWENT; IBM_TDB	OR	ON	2006/08/11 21:20
L14	139	13 same 7 and 7 near4 6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/11 21:37
L15	36	13 same 7 and 7 with 6 with (lower thin\$4 bevel\$4 facet\$4 round\$4 inclin\$4 declin\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/11 21:37
L16	83	(14 15) and (@ad < "20010123")	US-PGPUB; USPAT; DERWENT; IBM_TDB	OR	ON	2006/08/11 22:00
L17	47	(5 same 7 and 7 near4 6).CLM.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/11 21:36
L18	13	(13 same 7 and 7 near4 6).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/11 21:36
L19	6	(13 same 7 and 7 with 6 with (lower thin\$4 bevel\$4 facet\$4 round\$4 inclin\$4 declin\$4)).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/11 21:37

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L20	13	(13 same 7 and 7 near4 6).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/11 21:37
L21	56	17 18 19 20	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/11 21:43
L26	2616	(cypress adj semiconductor).as.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/11 21:45
L27	659	26 and 6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/11 21:46
L28	51	26 and (6 near4 5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/11 21:51
L29	3917	((257/701) or (257/730) or (257/e23. 167)).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/11 22:00
L30	929	(257/730).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/08/11 22:00
L31	329	30 and (@ad < "20010123")	US-PGPUB; USPAT; DERWENT; IBM_TDB	OR	ON	2006/08/11 22:00